



---

---

# Laser-based high-pressure, high-strain-rate materials experiments

---

---

**Daniel H. Kalantar** - Lawrence Livermore National Laboratory

*Presented by Thomas Lorenz*

**8<sup>th</sup> International Workshop on the Physics of Compressible Turbulent Mixing**  
Pasadena, CA - December 9-14, 2001

J. Belak, J. D. Colvin, M. Kumar, K. T. Lorenz, K. O. Mikaelian, S. Pollaine, B. A. Remington,  
S. V. Weber, L. G. Wiley (LLNL),  
J. S. Wark, A. Loveridge, A. M. Allen (University of Oxford), M. A. Meyers, M. Schneider (UCSD)

This work was performed under the auspices of the US DOE by UC LLNL under contract No. W-7405-48-Eng.  
Supported in part through the Science Use of Nova Program, DOE Grants program, and NLUF program (OMEGA).

# Outline

---

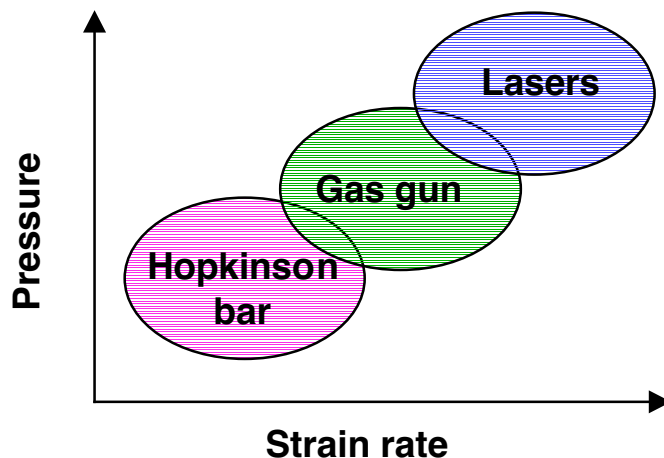


- **Introduction**
  - **Solid-state experiments at high pressure on a laser**
- **High pressure strength**
  - **RT instability in solid Al at high pressure to infer  $Y(P)$**
- **Dynamic material response**
  - **Dynamic x-ray diffraction of the lattice level response in Si and Cu**
- **Wave profile and residual deformation**
  - **VISAR measurement, sample recovery and characterization**

# The high pressure response of materials is of interest for many reasons; lasers provide a way to access high pressures and strain rates



- The core of the earth is Fe at 3 Mbar, both solid and liquid
  - Long time scale, diamond anvil experiments
- Survivability of passengers in a car crash depend on the material response of the car
  - ms- $\mu$ s time scale, Hopkinson bar and gun experiments
- Space station wall integrity from space debris, dust, micro-asteroids
  - $\mu$ s time scale, gun and high explosives experiments

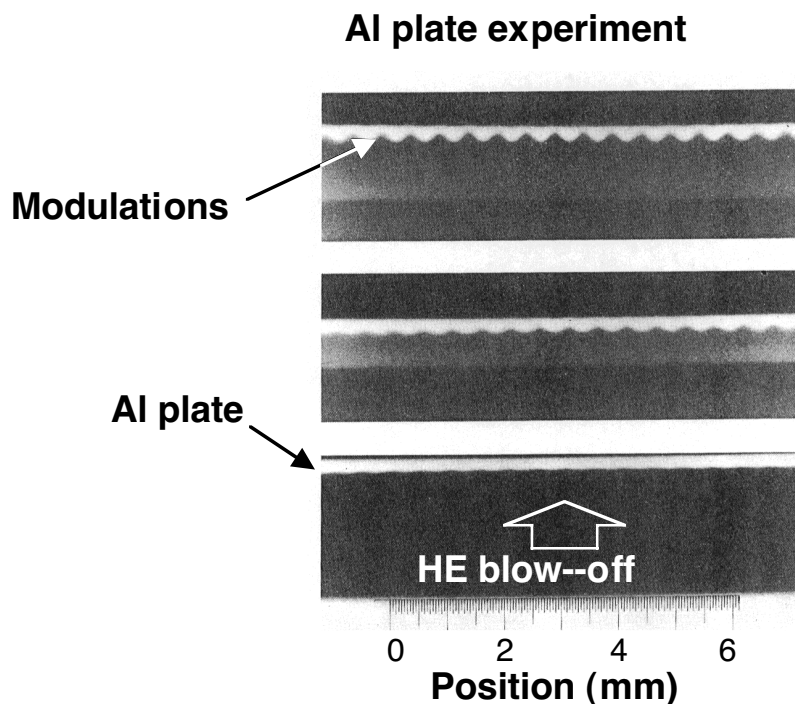


**Lasers access unique high pressure, high strain rate regime of material response to test the limits of theories and scaling laws**

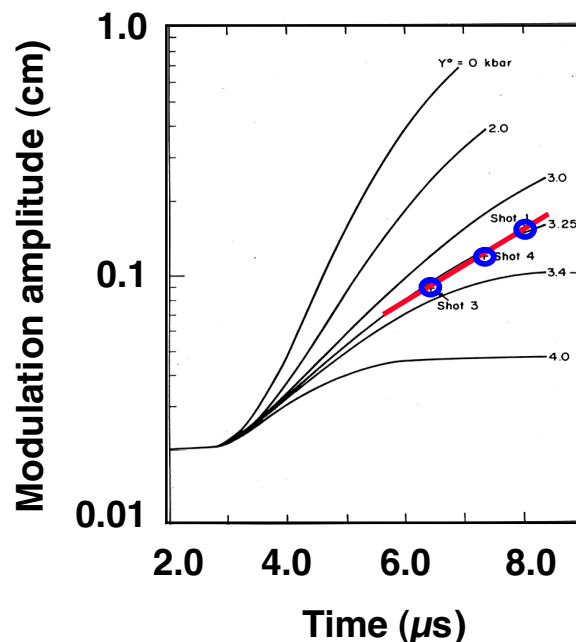
# Example - strength measurements at high pressure using a high explosive drive and modulated Al plate



- Shockless HE drive used to compress and accelerate a plate with pre-imposed modulations
- Pre-imposed modulations grow by the Rayleigh-Taylor instability
- The growth is reduced from classical (fluid) due to material strength



Growth is reduced from fluid



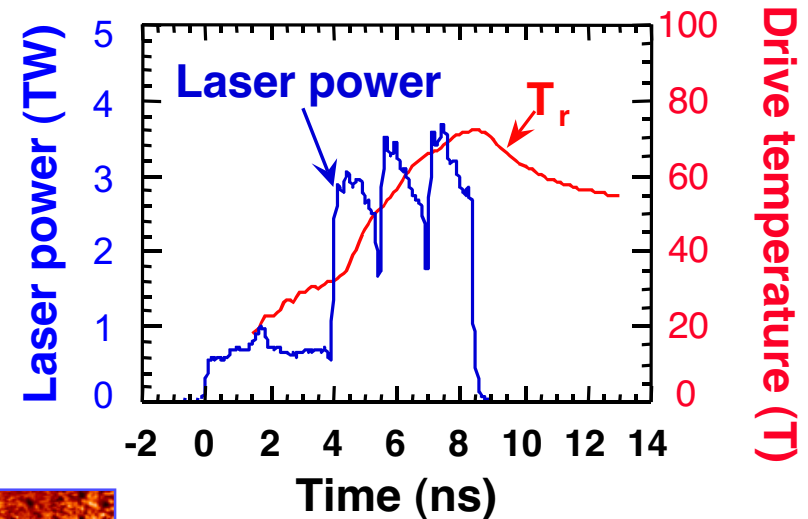
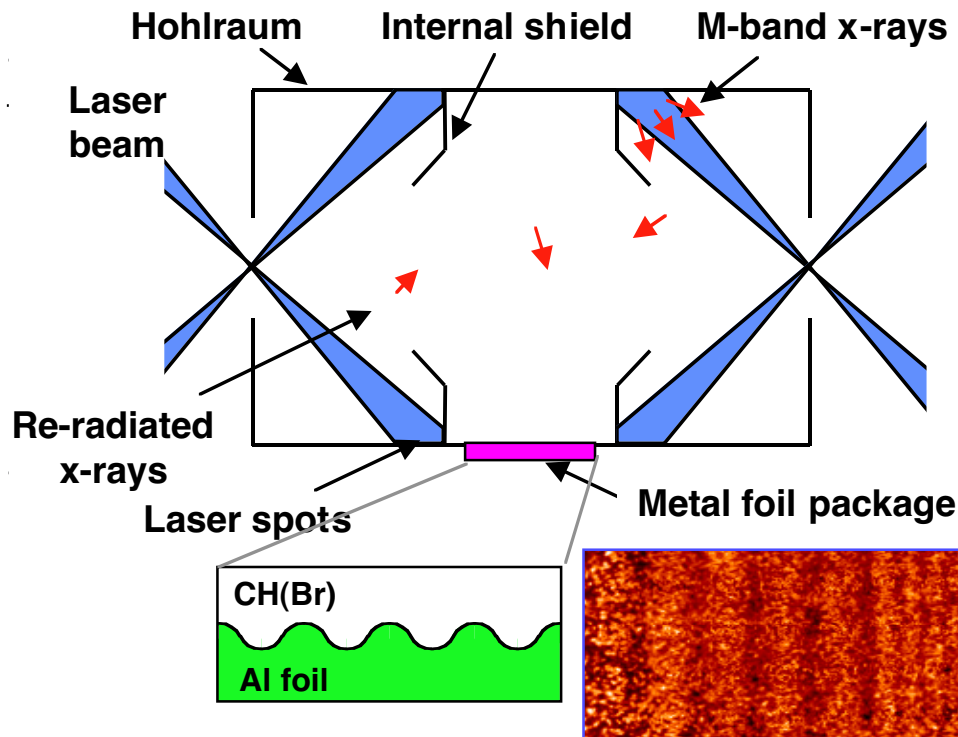
Barnes *et al*,  
J. Appl.  
Phys. 45,  
727 (1974).

Also  
Rayevsky  
and Lebedev

# 1. Solid state RT instability experiment



- An internally shielded hohlraum is used to shock compress an Al-6061 metal foil at high pressure
- Internal shields block hard x-rays from preheating package
- A shaped laser pulse generates a series of gentle shocks for nearly isentropic compression



# Detailed simulations predict that the Al foil remains solid throughout the experiment

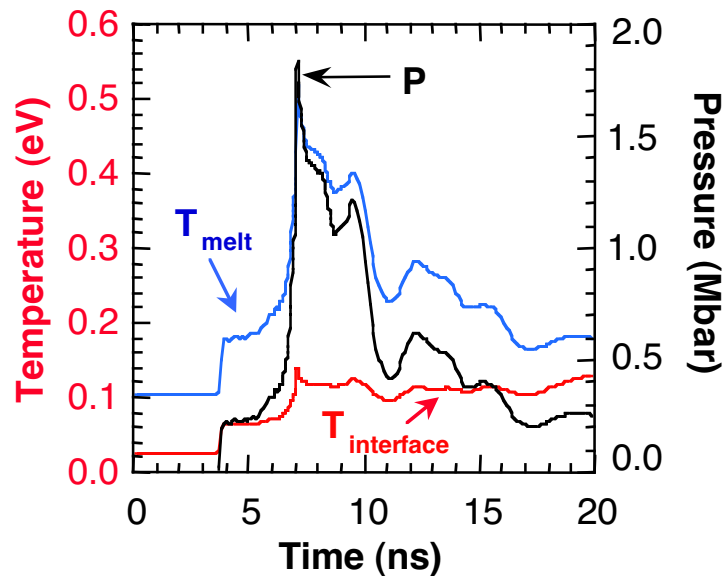


- The Al remains below the melt curve
- The foil trajectory is nearly isentropic to 1.8 Mbar

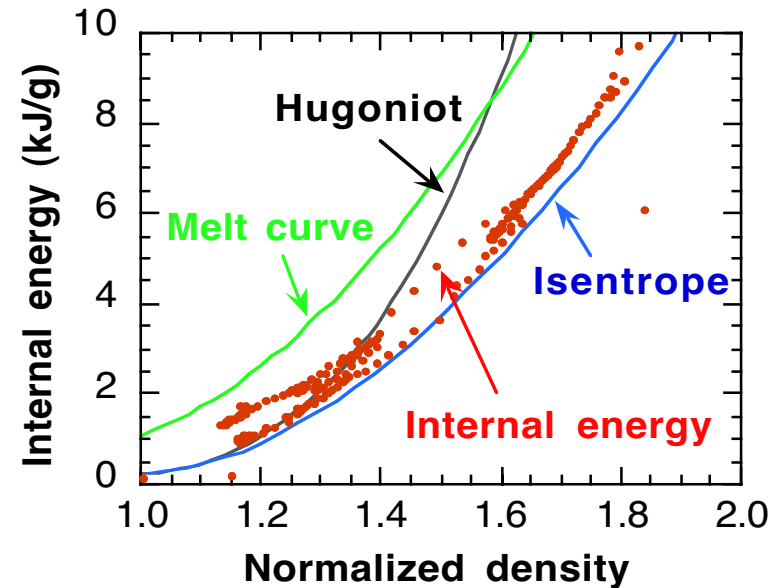
Lindemann melt model

$$T_m = T_{m_o} e^{2a(1-\eta)} \eta^{2(\gamma_o - a - 1/3)}$$

Pressure and temperature at the embedded interface



Calculated internal energy trajectory



# Simulations of the instability growth demonstrate sensitivity to the strength of the Al



- Growth rates with strength are expected to be reduced from classical (fluid)

Steinberg-Guinan constitutive model

$$Y = Y_o(1 + \beta(\varepsilon + \varepsilon_i))^n \frac{G(P, T)}{G_o}$$

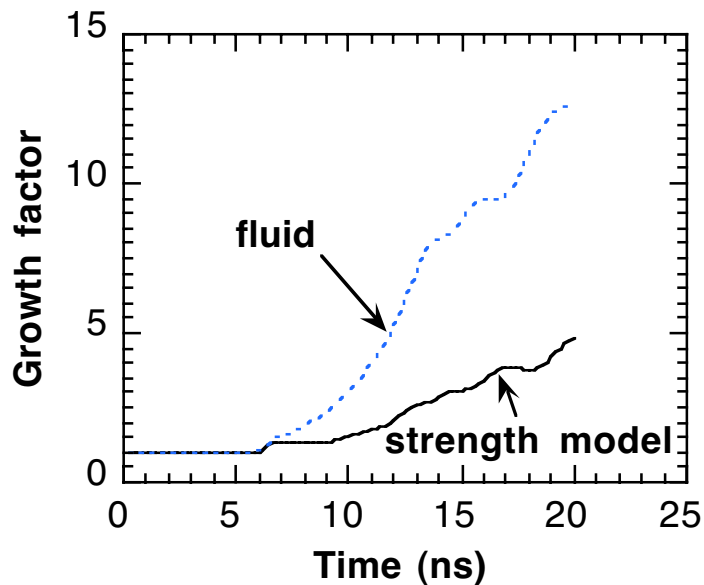
$$G = G_o \left( 1 + \left( \frac{G_P}{G_o} \right) \frac{P}{\eta^{1/3}} - \left( \frac{G_T}{G_o} \right) (T - 300) \right)$$

Rayevsky Stability boundary formula

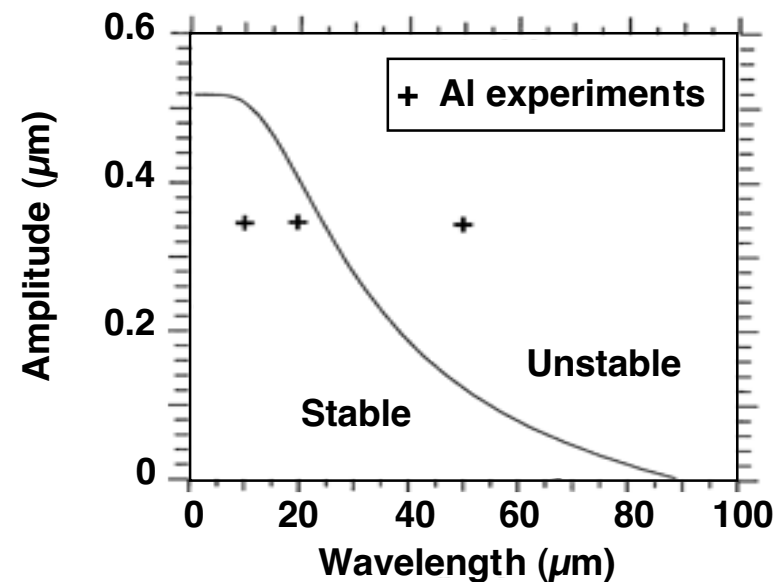
$$\eta_c = \eta_D \left[ 1 - 0.86 e^{-\frac{2\pi H}{\sqrt{3}\lambda}} \right] \left\{ \left[ 1 - e^{-\frac{2\pi H}{\sqrt{3}\lambda}} \right]^2 - \left[ \frac{\lambda}{\lambda_M} \right]^2 \right\}$$

$$\eta_D = \frac{2Y}{\rho g} \quad \lambda_M = \frac{4\pi G}{\rho g}$$

Predicted growth factors  $\lambda=20 \mu\text{m}$



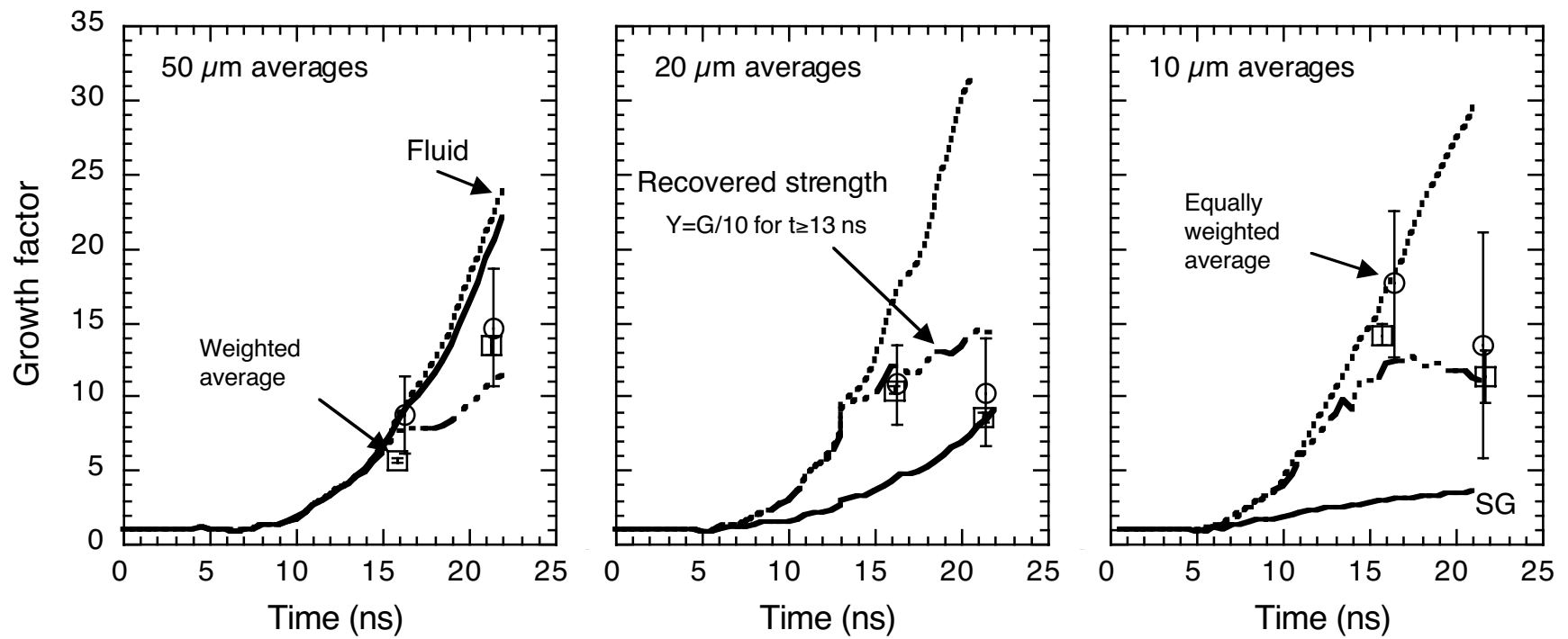
Stability curve (Nizovtsev and Rayevsky, 1991)



# The RT growth is nearly fluid at early times, but it is suppressed at later times



- Experiments were conducted with 10, 20 and 50  $\mu\text{m}$  wavelengths
- Modeling was done assuming the following:
  - Fluid
  - Nominal Steinberg-Guinan
  - Fluid until 13 ns, then S-G with theoretical maximum  $Y=G/10$



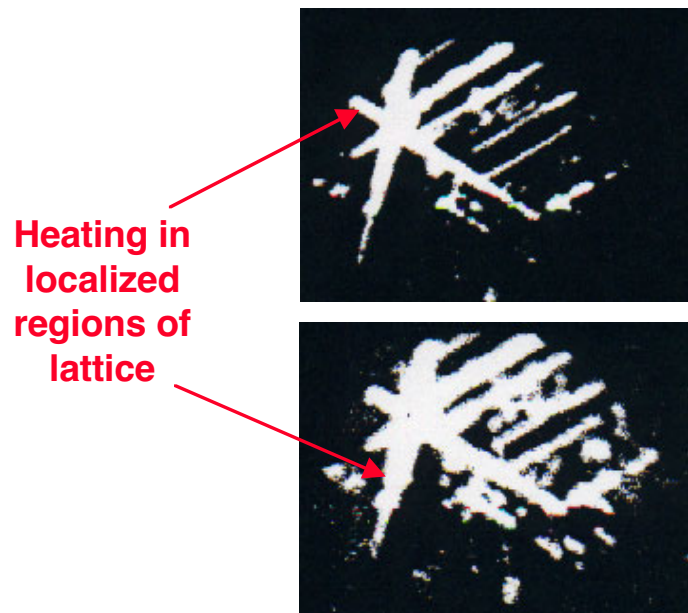


# The RT growth is nearly fluid at early times, but it is suppressed at later times; suggestive of model from Grady/Asay and data by Rayevsky and Lebedev



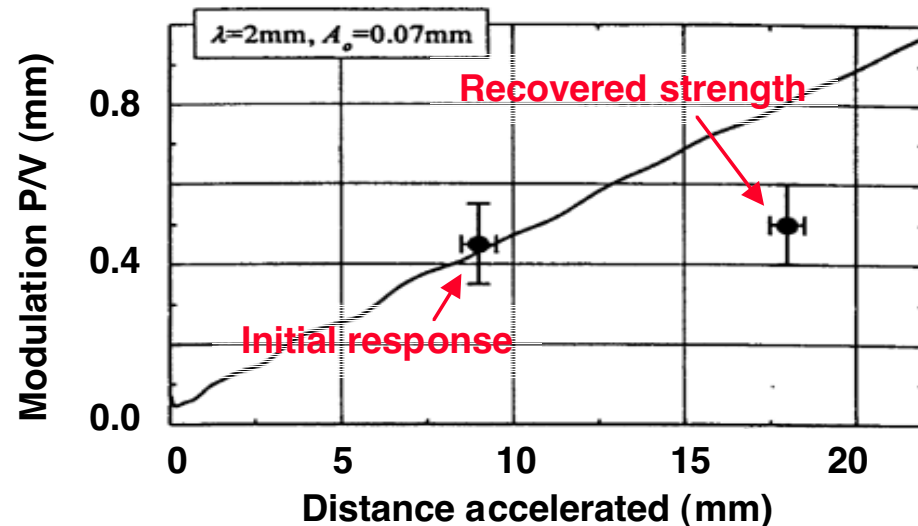
- High pressure strain causes localized heating and softening in shear bands; bulk Al flows as fluid due to localized deformation
- As heat conducts into the bulk material, the metal regains bulk solid strength and continued growth is inhibited

Optical emission from shocked quartz



Brannon *et al*, SCCM 1983.

Shocked HE experiments show fluid-like response with saturation

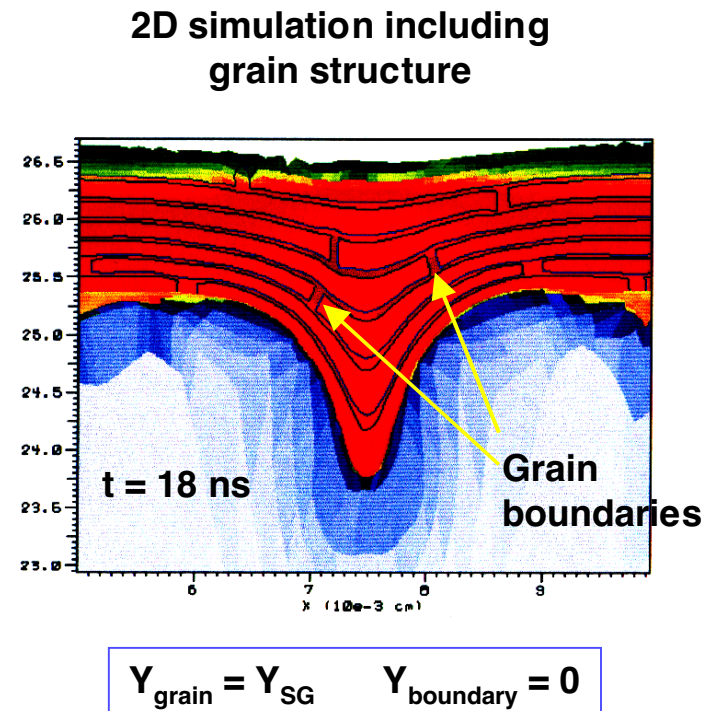
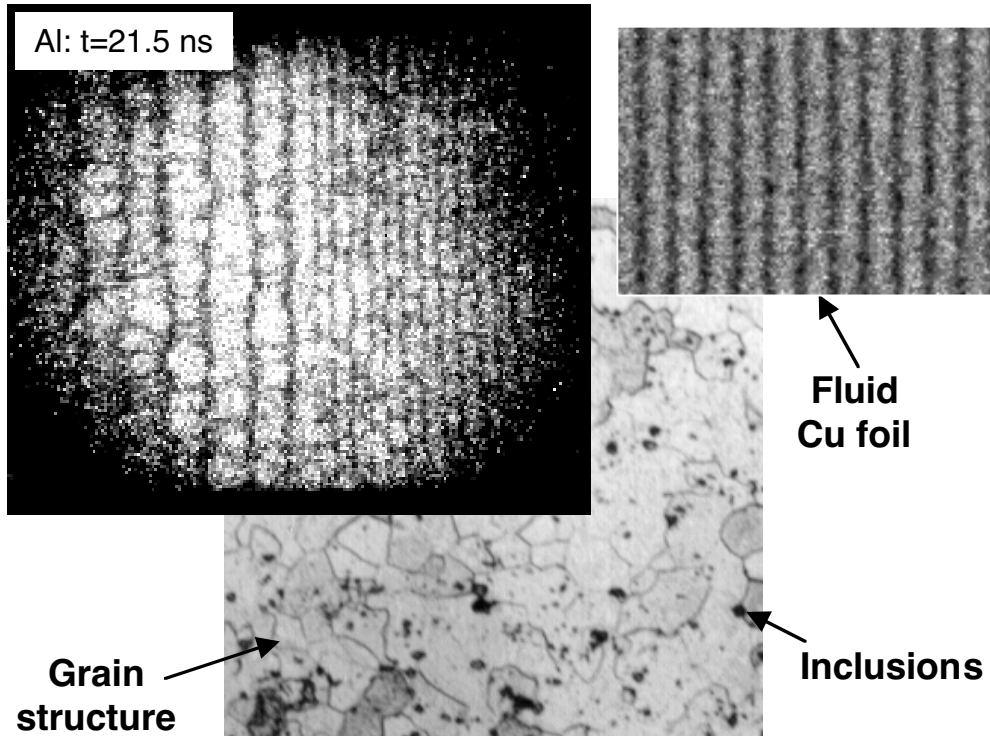


Rayevsky *et al*, IWPCTM, 1999.

# The late time images show features that may be due to hydrodynamic imprinting of the grain structure



- The spatial scale of the late-time modulation is similar to initial grain structure
- 2D simulations incorporating the grain boundaries start to show effects at  $t=18$  ns, 3D simulation has been started

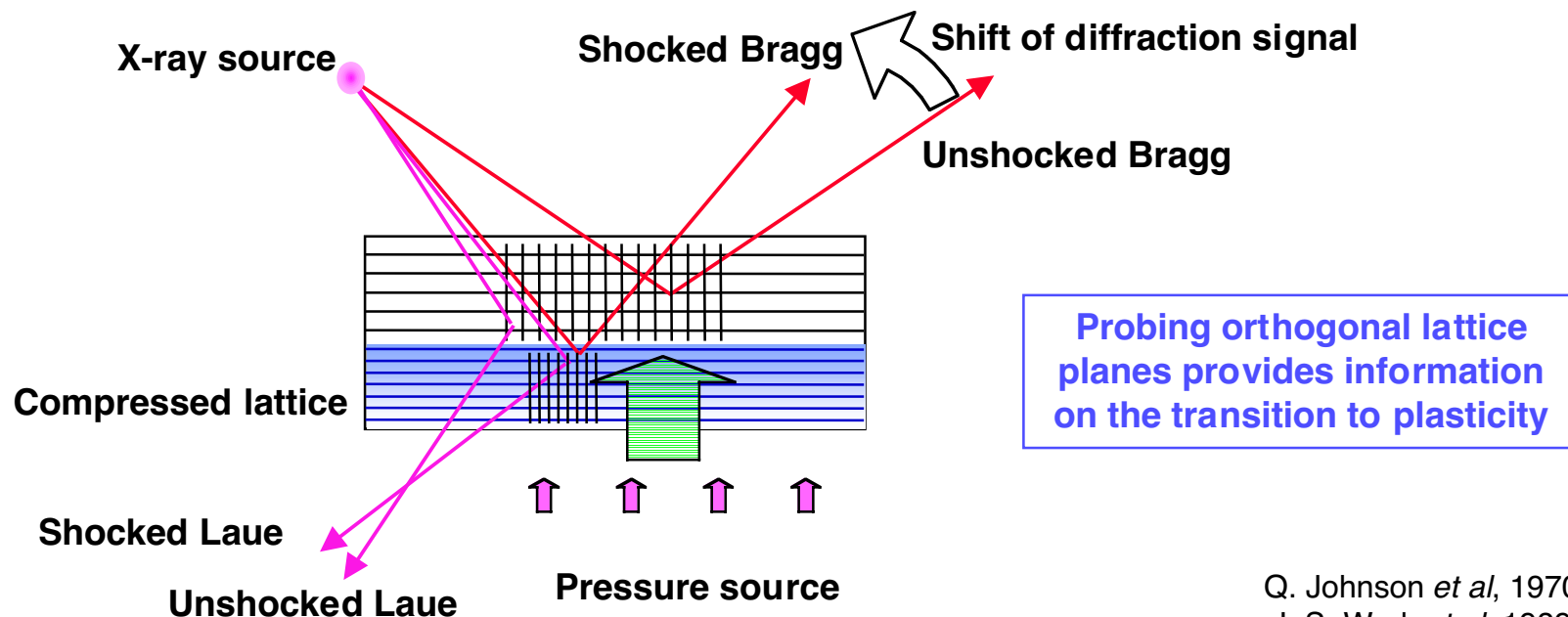


Simulations by G. Bazan, 2001

## 2. Dynamic x-ray diffraction



- *In situ* x-ray diffraction probes the long range lattice order under shock compression
- Shock pressure generated using a hohlraum x-ray drive or by direct laser irradiation
- Time-resolution with x-ray streak cameras provides information on dynamic lattice response

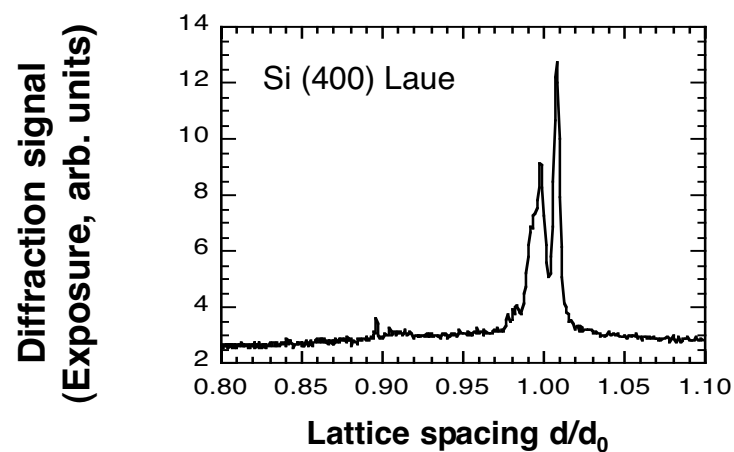
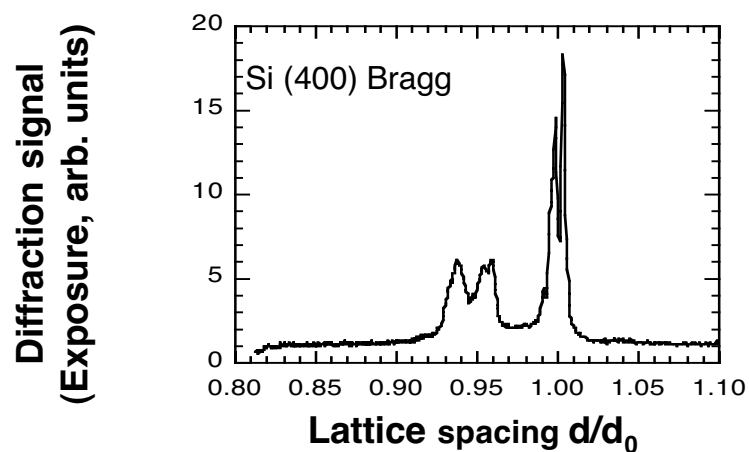
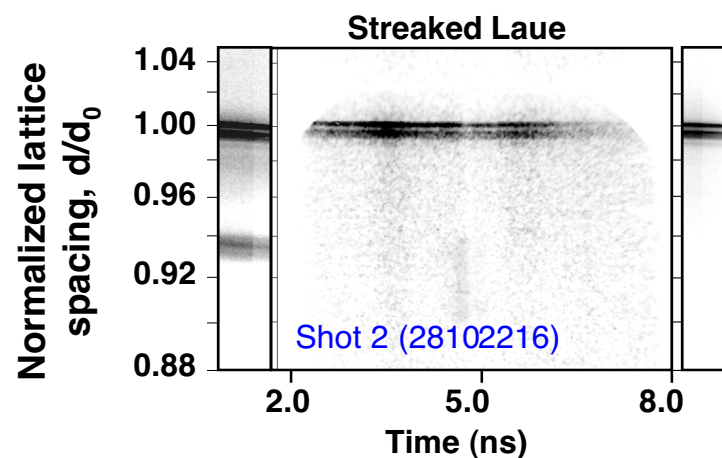
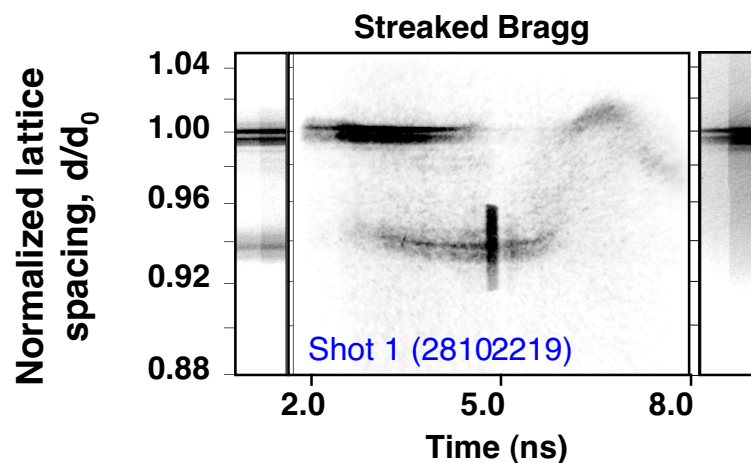


Q. Johnson *et al*, 1970;  
J. S. Wark *et al*, 1989.

# Simultaneous measurements of orthogonal planes indicates Si responds uniaxially on a ns time scale



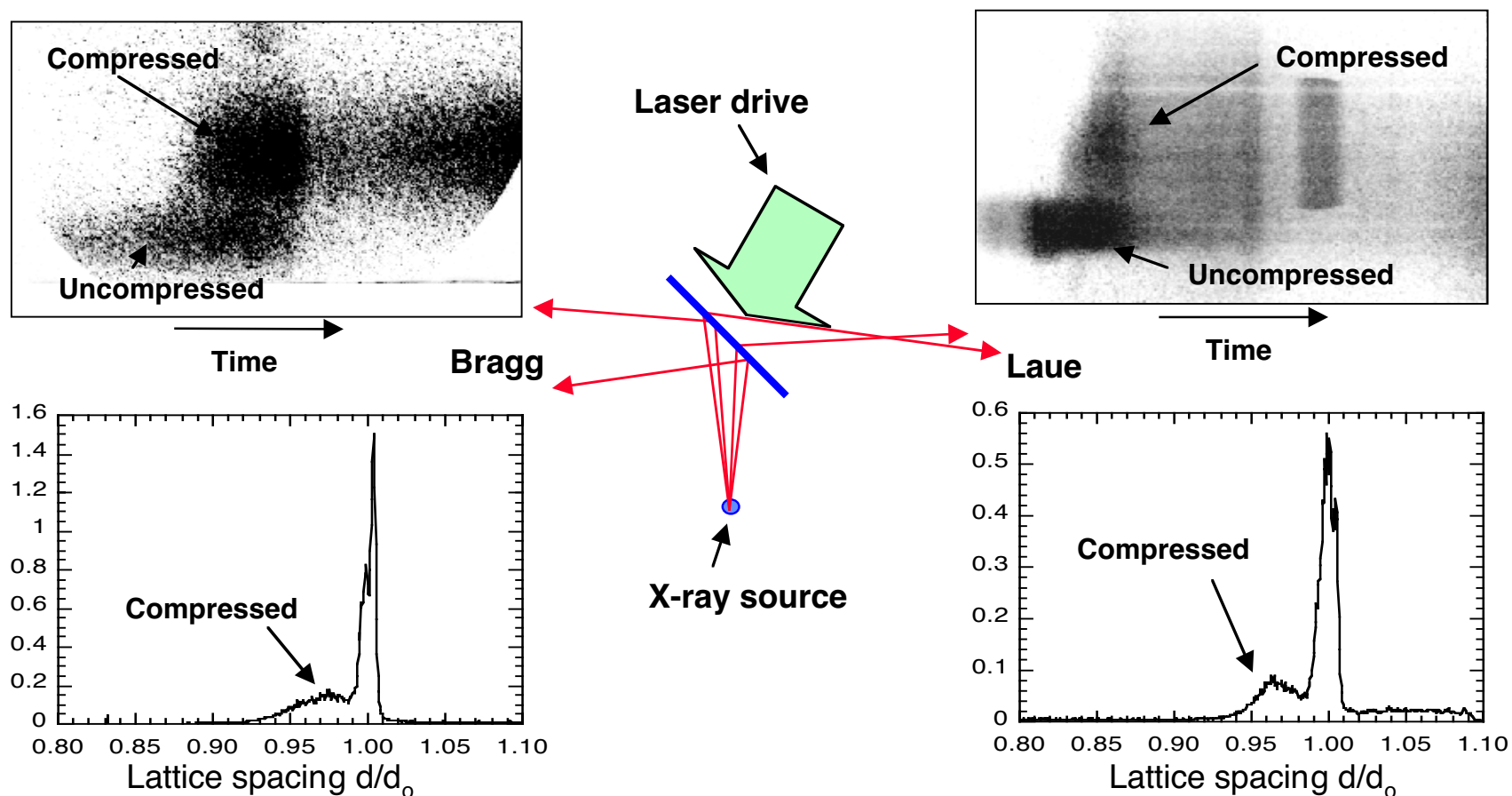
- 40  $\mu\text{m}$  thick Si shocked along (100) axis
- P=115-135 kbar; HEL=84 kbar



# Cu undergoes a transition to 3D lattice compression at high pressure



- 8  $\mu\text{m}$  single crystal Cu shocked along (100) axis
- $P = 180$  kbar; HEL  $\sim 2$  kbar



# The timescale for plastic deformation in Si is much longer than for Cu based on Orowan's equation



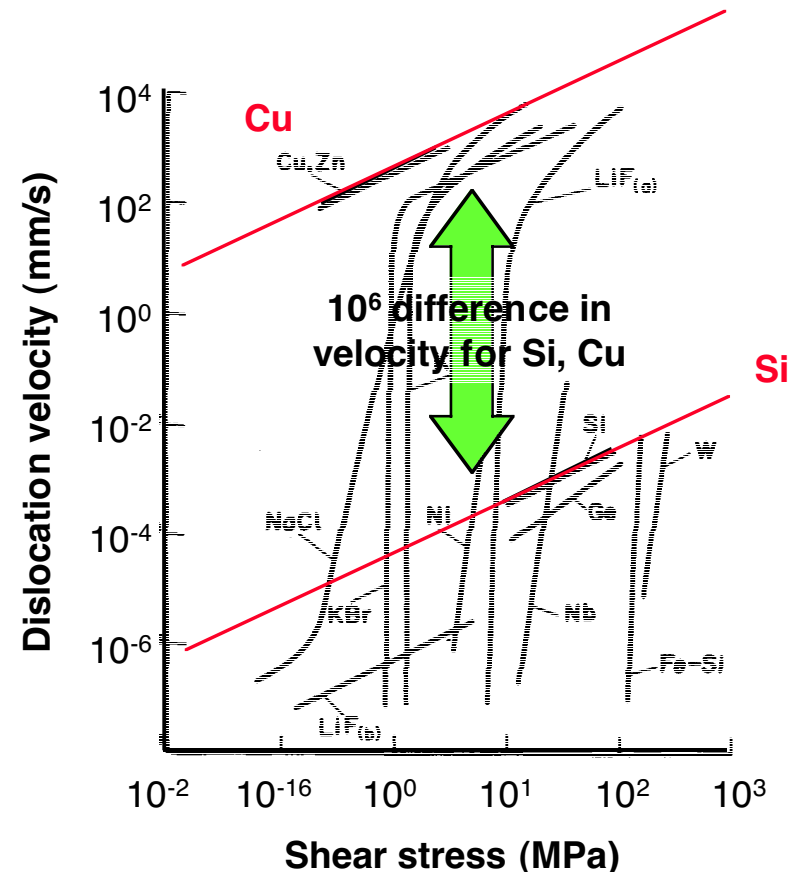
$$\text{Orowan equation: } \frac{\Delta\varepsilon}{\Delta t} = N |b| v$$

## Silicon

- $\Delta t > 1 \mu\text{s}$  : dislocations do not move
  - 5% strain, dislocations separated by at least the Burger's vector (3.8 Å) (diffraction linewidth indicates  $N < 10^{14} \text{ m}^{-2}$ )
  - Linear extrapolation of dislocation velocity in Si (0.1 mm/s)

## Copper

- $\Delta t < 10 \text{ ps}$  : dislocations do move
  - 5% strain, dislocations separated by at least the Berger's vector (2.5 Å)
  - Velocity of dislocations calculated to be 400 m/s in MD simulations



Introduction to Dislocations, Hull and Bacon (Fig. 3.12)

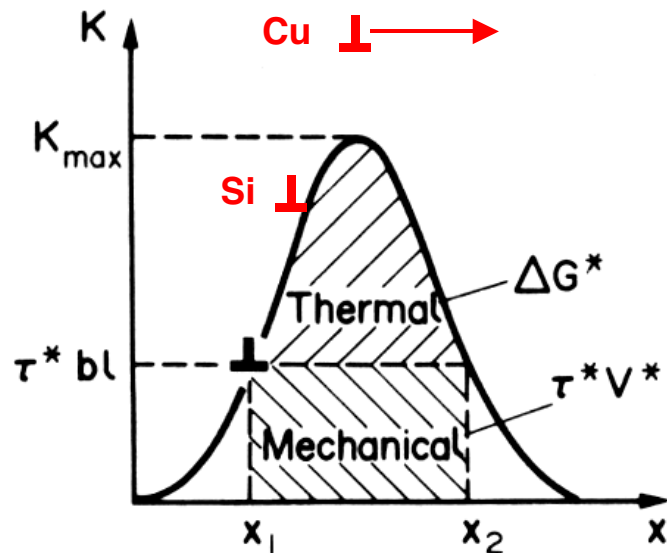
# The time scale for plastic deformation in Si is much longer than for Cu, due to its high Peierls barrier and activation energy



- For  $\sigma < Y_p$ : thermal activation regime, and

$$t = t_{wait} = \frac{1}{v_{attempt} \exp\left[\frac{-\Delta F}{kT} \left(1 - \frac{\sigma}{Y_p}\right)^2\right]}$$

- For  $\sigma > Y_p$ : phonon drag regime,  $t = t_{run} = \frac{aB}{\sigma b}$



Assume that  $\sigma = 3$  GPa, and  $kT = 0.05$  eV:

**For Si:**

$$Y_p = 0.07G_0(1+AP/\eta^{1/3}) > 0.07G_0$$

giving  $Y_p > 0.07$  (63.7 GPa) = 4.5 GPa,  
 $\Delta F = 0.2Gb^3 = 0.2$  (63.7GPa) (3.83 Å)<sup>3</sup> = 4.5 eV

So  $\sigma < Y_p$ , and  $kT \ll \Delta F$ : thermal activ. regime

Assume  $v_{attempt} = v_{Debye}/100 = 10^{11} \text{ s}^{-1}$ ,  
 So  $1/t_{wait} = (10^{11} \text{ s}^{-1}) \exp[-(4.5/0.05) (1 - 3/4.5)^2]$

Giving  $t_{wait} > \sim 150$  ns, meaning **slow**

**For Cu:**

$$Y_p = (6.3 \times 10^{-3})G_0(1+AP/\eta^{1/3}) = 0.42 \text{ GPa}$$

So  $\sigma > Y_p$ , meaning phonon drag regime

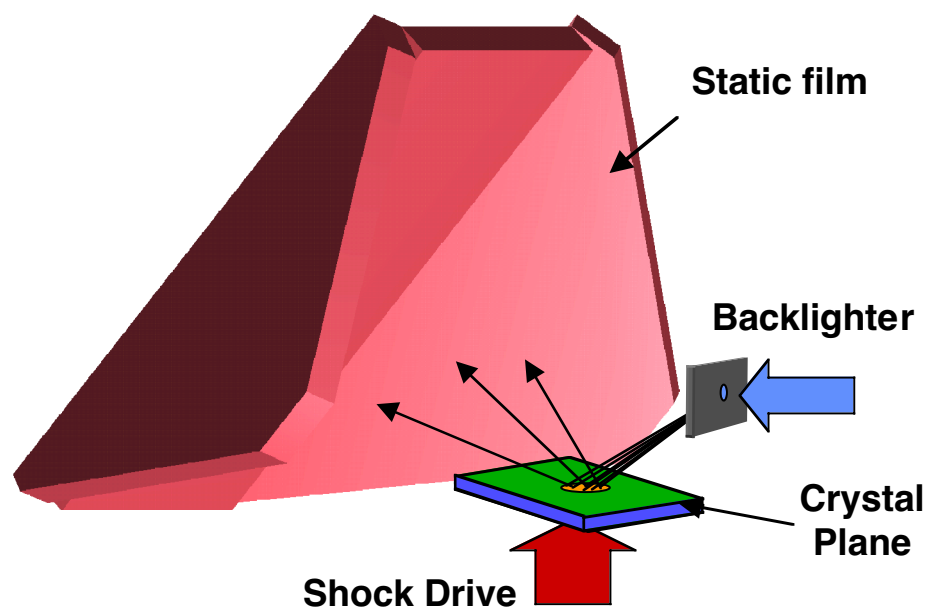
Assume  $B = 10^{-10} \text{ MPa}\cdot\text{s}$ , and  $a/b < 10^3$ ,

So  $t_{run} < (10^3) (10^{-10} \text{ MPa}\cdot\text{s})/(3 \text{ GPa}) = 30 \text{ ps}$ : **fast**

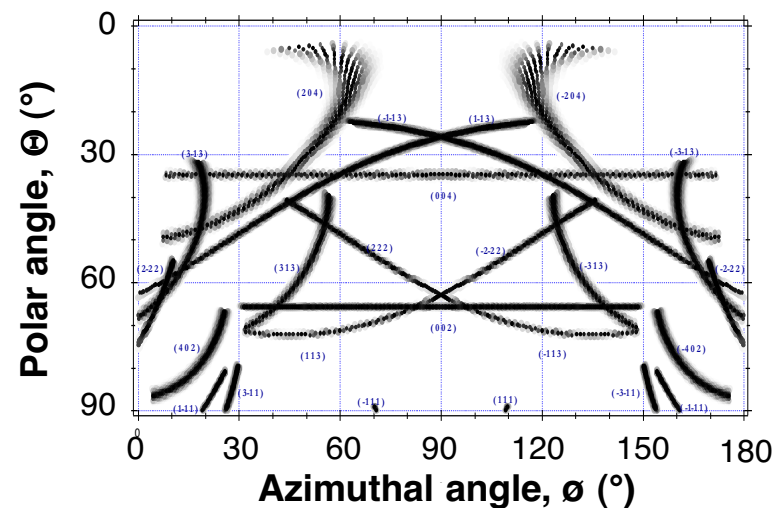
# A new wide-angle film detector is used to record many more lattice planes



- X-rays diffracted from orthogonal lattice planes are recorded with 2 x-ray streak cameras
- A segmented film assembly records x-rays diffracted over a  $\pi$ -solid angle from many more lattice planes



Calculated diffraction pattern from static Cu

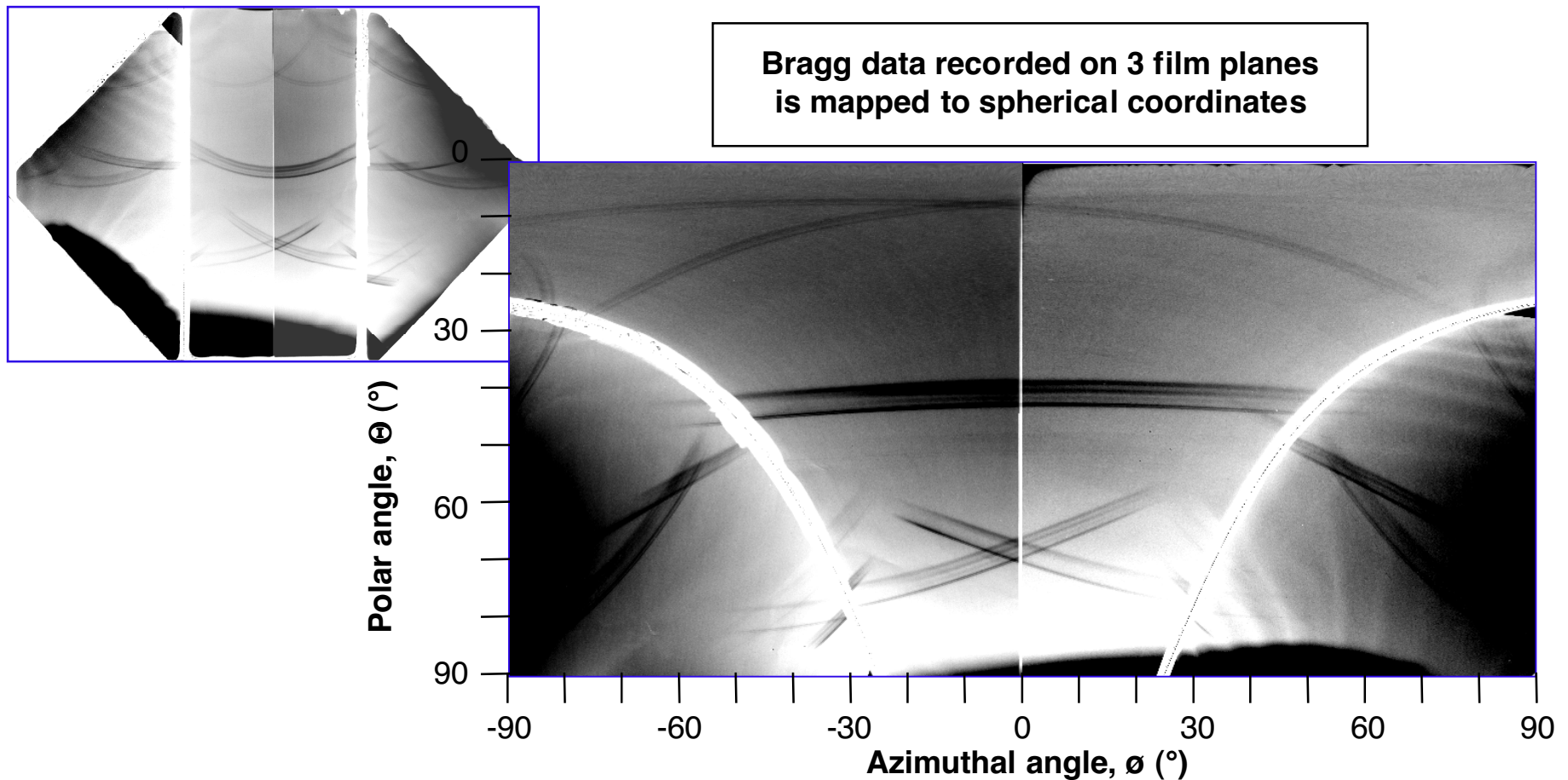




# Detailed response of the lattice is better understood by recording diffraction from other lattice planes



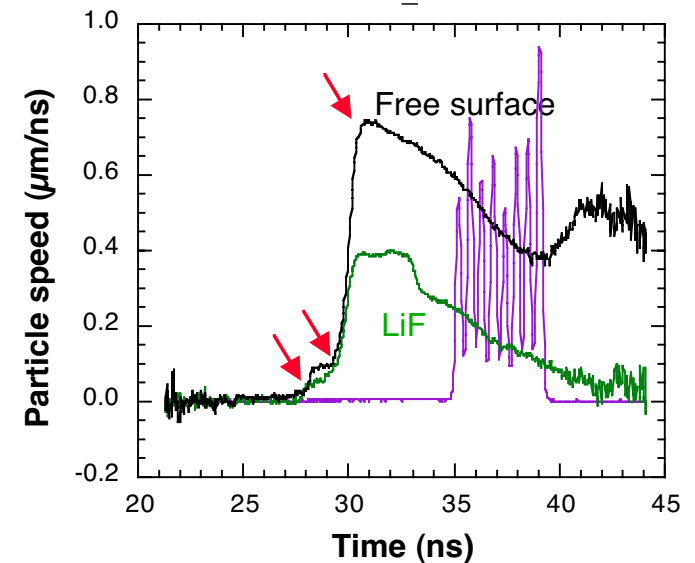
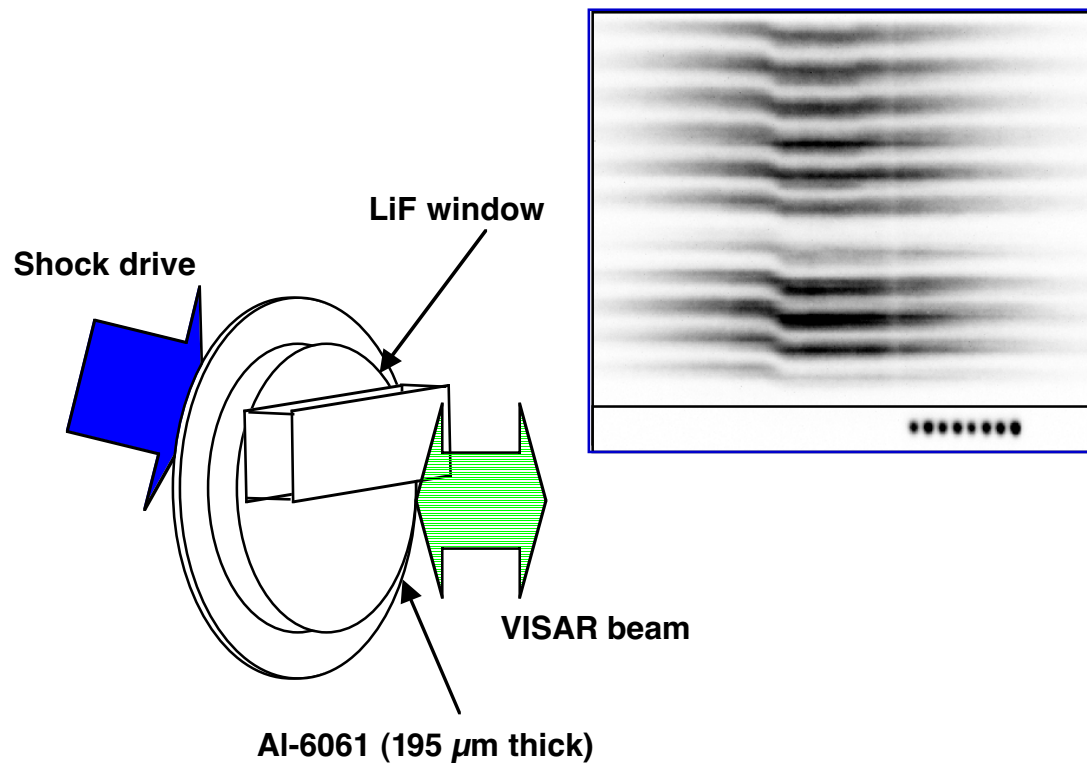
- Large angle detector has been fielded on Si shock experiments
- Shift of many different lines is observed; details are being studied



### 3. VISAR wave profiles and sample recovery



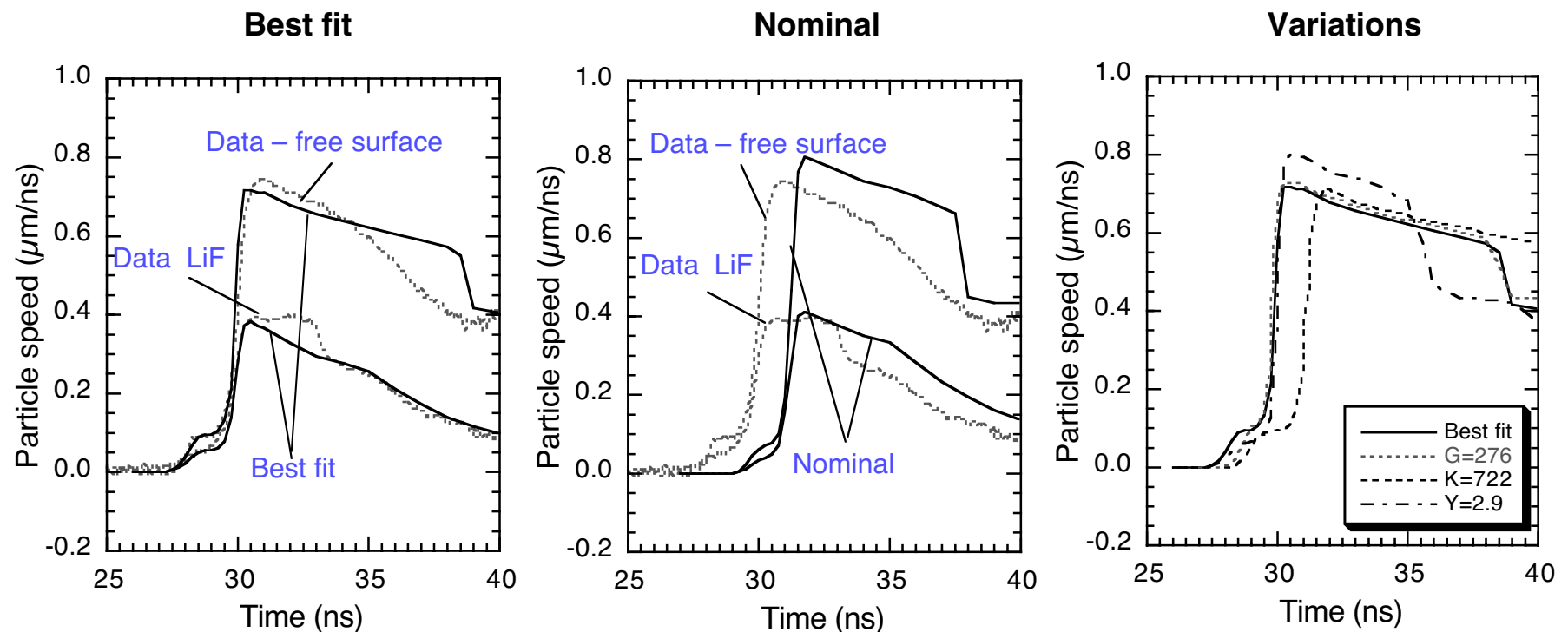
- Al-6061 wave profile measurements show elastic-plastic response with spall on release
- Fitting the shock breakout wave profile provides best-fit strength parameters



# VISAR wave profiles provide information on the strength parameters for the shocked metal



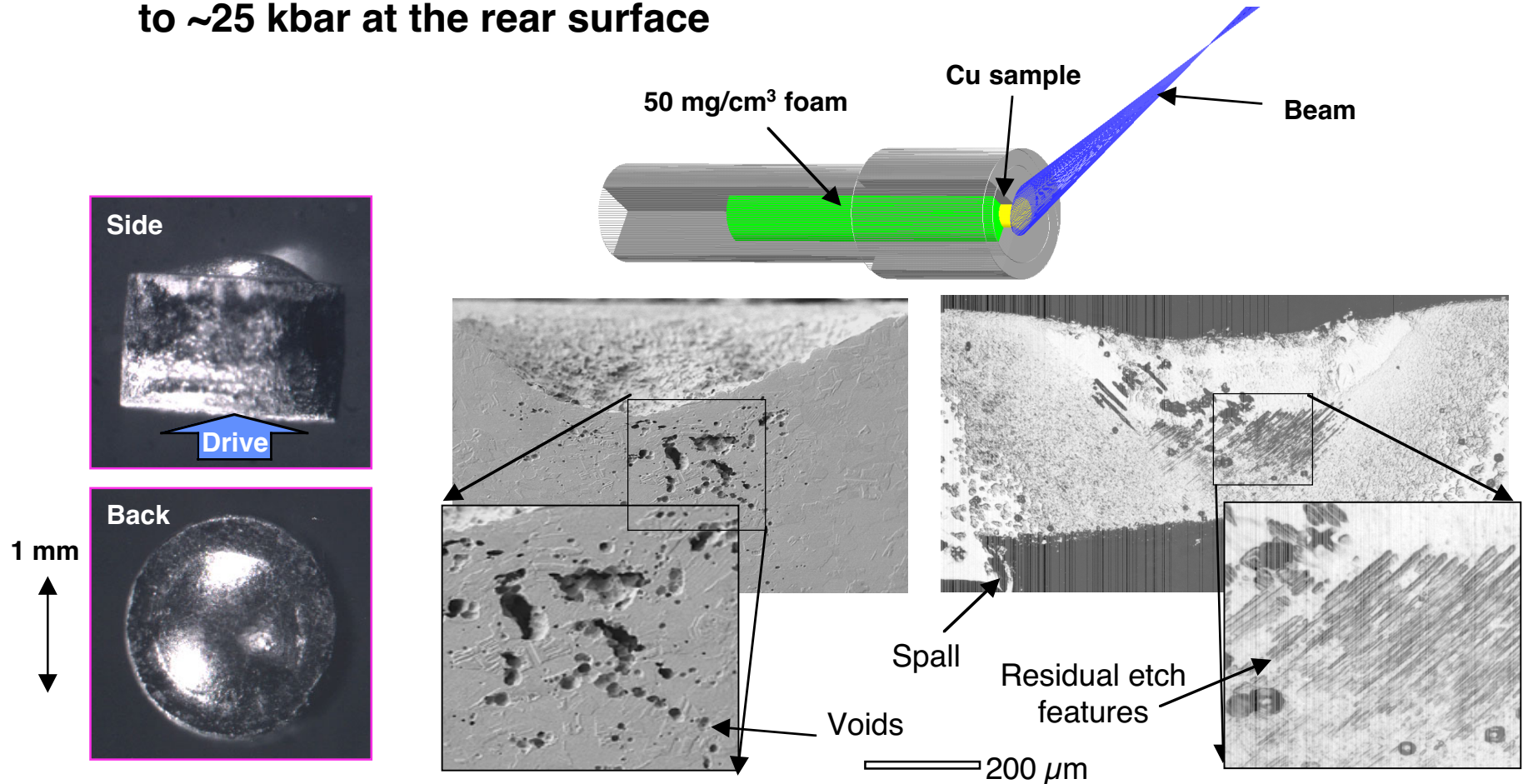
- The wave profile is sensitive to the constitutive model parameters for the metal foil
- Best-fit wave profile provides model parameters:
  - Shear modulus  $G=320$  kbar (276)
  - Bulk modulus  $K=794$  kbar (742)
  - Yield strength  $Y=4.27$  kbar (2.9)



# Transmission electron and optical microscope analysis shows residual structure that depends on the drive conditions



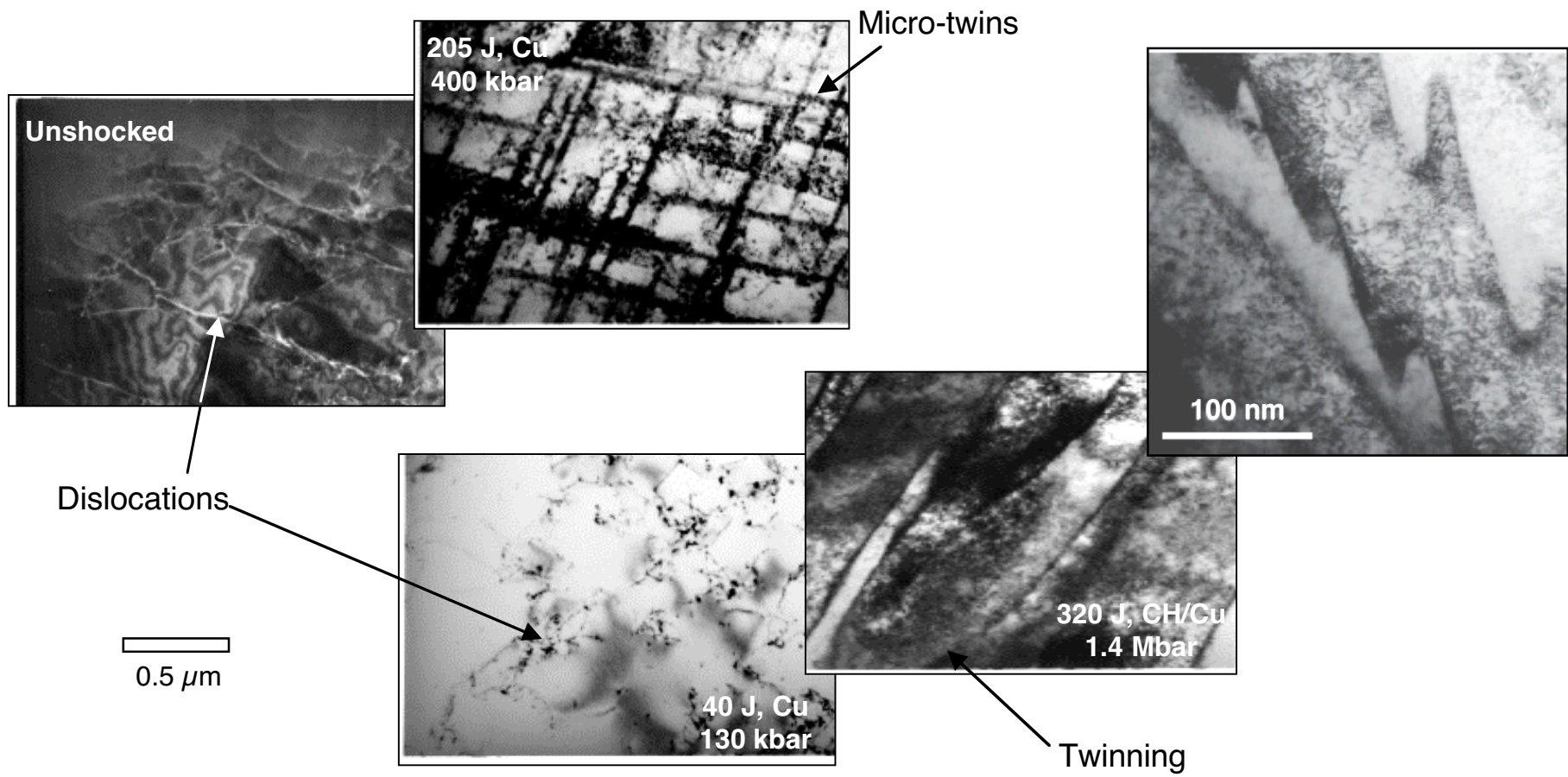
- Shocked samples are recovered in a low density foam-filled tube
- Preliminary tests done at OMEGA; shock pressure is  $\sim 400$  kbar, decays to  $\sim 25$  kbar at the rear surface



# TEM analysis of recovered Cu shows the residual microstructure



- Residual microstructure of recovered single crystal Cu samples
- Higher pressures show twinning



# Summary

---



- **Solid state hydrodynamic instability**
  - RT instability in Al to infer  $Y(P)$
  - There is possible imprinting due to the initial grain structure
- **In situ dynamic x-ray diffraction**
  - Time-resolved diffraction relates the lattice behavior to the macroscopic response of Si and Cu under shock loading
  - Si responds uniaxially, Cu deforms plastically
- **Shock/recovery experiments**
  - Residual deformation structure in Cu depends on the shock pressure